Schlage Wafer

MACS:	N/A
Increment:	.060"
Progression:	N/A
E.P.D.	N/A
Included Angle:	90°
Root Cut:	.060"

Key Origination	
Blackhawk	N/A
CodeMax	DSD #3360
HPC Blitz	N/A
HPC Punch	N/A
ITL	392

Root Depths	
0	No Cut
1	.235"

Spacing	
1	1.090"
2	.965"
3	840"
4	715"
5	590"
6	.465"
7	.340"
8	.229"

Notes
1) Read and cut tip-to-bow.
2) Index from tip.
3) Combnation wafers are matched to each cut on the key.
4) Series wafers are used in each uncut position.
5) Master wafers are only used in the tip position and determine tip cut.

T.F.C:	.275"
B.C.C:	.125"

Tip*	1**	2	3	4	5	6	7	8	Bow*
	20	2	4	6	8	0	2	4	
	10	1	3	5	7	9	1	3	

*Use chart to decode keys/bitting codes. Key is read tip to bow, with raised rib and coining facing you.

**Position 0 is the "series" cut and is determined by the orientation of the plug chambers, this cut extends from the cut center to the end of the ke

**Bitting codes are six digits or six digits preceeded by a "W". The first digit is always either 1 or 2 and indicate the series cut

**A "W" prefix to the bitting code indicates the use of the W keyway (SC22/1307W blanks), otherwise keys should be cut on a SC6/1307A blank.

**The second digit of a bitting code indicates master keying options. 0 is non-master keyed, 1 is master keyed.

**The remaining 4 digits of the bitting code indicate where cuts will be made, cuts are never directly opposite eachother.

**Cut at position 0 is .252" wide extending all the way to the tip of the blank.

Notes:

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